## OVERVIEW

The WF5027 series are miniature crystal oscillator module ICs. The oscillator circuit stage has voltage regulator drive, significantly reducing current consumption and crystal current, compared with existing devices, and significantly reducing the oscillator characteristics supply voltage dependency. There are 3 pad layout package options available for optimized mounting, making these devices ideal for miniature crystal oscillators.

## FEATURES

■ Wide range of operating supply voltage: 1.60 to 3.63 V

- Regulated voltage drive oscillator circuit for reduced power consumption and crystal drive current
- Optimized low crystal drive current oscillation for miniature crystal units
- 3 pad layout options for mounting
- $5027 \mathrm{~A} \times, \mathrm{M} \times, \mathrm{Q} \times$ series: for Flip Chip Bonding
- $5027 \mathrm{~B} \times, \mathrm{N} \times, \mathrm{R} \times$ series: for Wire Bonding (type I)
- $5027 \mathrm{C} \times, \mathrm{P} \times, \mathrm{S} \times$ series: for Wire Bonding (type II)
- Recommended oscillation frequency range


## For fundamental oscillator

- Low frequency version: 20 MHz to 60 MHz
- High frequency version: 60 MHz to 100 MHz


## For 3rd overtone oscillator

- Low frequency version: 40 MHz to 110 MHz
- High frequency version ${ }^{* 1}: 110 \mathrm{MHz}$ to 180 MHz *1: under development
- Multi-stage frequency divider for low-frequency output support: $0.9 \mathrm{MHz}(\mathrm{min})$
- Frequency divider built-in (for fundamental oscillator)
- Selectable by version: $\mathrm{f}_{\mathrm{O}}, \mathrm{f}_{\mathrm{O}} / 2, \mathrm{f}_{\mathrm{O}} / 4, \mathrm{f}_{\mathrm{O}} / 8, \mathrm{f}_{\mathrm{O}} / 16$, $\mathrm{f}_{\mathrm{O}} / 32, \mathrm{f}_{\mathrm{O}} / 64$
- -40 to $85^{\circ} \mathrm{C}$ operating temperature range
- Standby function
- High impedance in standby mode, oscillator stops
- CMOS output duty level (1/2VDD)
- $50 \pm 5 \%$ output duty
- 15 pF output drive capability
- Wafer form (WF5027×x)

Chip form (CF5027××)

## APPLICATIONS

- $3.2 \times 2.5,2.5 \times 2.0,2.0 \times 1.6$ size miniature crystal oscillator modules


## ORDERING INFORMATION

| Device | Package |
| :---: | :---: |
| WF5027××-4 | Wafer form |
| CF5027××-4 | Chip form |

## SERIES CONFIGURATION

## For Fundamental Oscillator

| Operating supply voltage range [V] | Output drive capability [mA] | PAD layout | Recommended oscillation frequency range* ${ }^{* 1}$ [MHz] | Version ${ }^{*}$ |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{f}_{0}$ output | $\mathrm{f}_{0} / 2$ output | $\mathrm{f}_{0} / 4$ output | $\begin{gathered} \mathrm{f}_{\mathrm{O}} / 8 \\ \text { output } \end{gathered}$ | $\mathrm{f}_{\mathrm{O}} / 16$ output | $\begin{gathered} \mathrm{f}_{\mathrm{O}} / 32 \\ \text { output } \end{gathered}$ | $\mathrm{f}_{0} / 64$ output |
| 1.60 to 3.63 | $\pm 4$ | Flip Chip Bonding | 20 to 60 | 5027A1 | 5027A2 | 5027A3 | 5027A4 | 5027A5 | 5027A6 | 5027A7 |
|  |  |  | 60 to 100 | 5027AP | 5027AQ | 5027AR | 5027AS | 5027AT | 5027AV | 5027AW |
|  |  | Wire Bonding Type I | 20 to 60 | 5027B1 | 5027B2 | 5027B3 | 5027B4 | 5027B5 | 5027B6 | 5027B7 |
|  |  |  | 60 to 100 | 5027BP | 5027BQ | 5027BR | 5027BS | 5027BT | 5027BV | 5027BW |
|  |  | Wire Bonding Type II | 20 to 60 | 5027C1 | 5027C2 | 5027C3 | 5027C4 | 5027C5 | 5027C6 | $5027 C 7$ |
|  |  |  | 60 to 100 | 5027CP | 5027CQ | 5027CR | 5027CS | 5027CT | 5027CV | 5027CW |

*1. The recommended oscillation frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated
*2. Wafer form devices have designation WF5027 $\times \times$ and chip form devices have designation CF5027 $\times \times$.
For 3rd Overtone Oscillator

| Operating supply voltage range [V] | Output drive capability [mA] | PAD layout | Recommended oscillation frequency range ${ }^{* 1}[\mathrm{MHz}]$ and version ${ }^{* 2}$ |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | 40 to 50 | 50 to 65 | 65 to 85 | 85 to 110 | 110 to 145 | 145 to 180 |
| 1.60 to 3.63 | $\pm 8$ | Flip Chip Bonding | 5027MA | 5027MB | 5027MC | 5027MD | (5027QE) | (5027QF) |
|  |  | Wire Bonding Type I | 5027NA | 5027NB | 5027NC | 5027ND | (5027RE) | (5027RF) |
|  |  | Wire Bonding Type II | 5027PA | 5027PB | 5027PC | 5027PD | (5027SE) | (5027SF) |

*1. The recommended oscillation frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.
*2. Wafer form devices have designation WF5027×× and chip form devices have designation CF5027××.
Versions in parentheses ( ) are under development.

## VERSION NAME

| Device | Package | Version name |
| :---: | :---: | :---: |
| WF5027××-4 | Wafer form |  |
| CF5027xx-4 | Chip form |  |

## PAD LAYOUT

(Unit: $\mu \mathrm{m}$ )

- $5027 \mathrm{~A} \times, \mathrm{M} \times, \mathrm{Q} \times$ (for Flip Chip Bonding)


Chip size: $0.75 \times 0.69 \mathrm{~mm}$
Chip thickness: $130 \pm 15 \mu \mathrm{~m}$
PAD size: 90 um
Chip base: $V_{S S}$ level

- $5027 \mathrm{~B} \times, \mathrm{N} \times, \mathrm{R} \times$ (for Wire Bonding (type I))

Chip size: $0.75 \times 0.69 \mathrm{~mm}$ Chip thickness: $130 \pm 15 \mu \mathrm{~m}$ PAD size: $90 \mu \mathrm{~m}$ Chip base: $\mathrm{V}_{S S}$ level

- $5027 \mathrm{C} \times, \mathrm{P} \times, \mathrm{S} \times$ (for Wire Bonding (type II))



## PAD DIMENSIONS PIN DESCRIPTION

|  | Pad dimensions $[\mu \mathrm{m}]$ |  |
| :---: | :---: | :---: |
| Pad No. | $\mathbf{X}$ | $\mathbf{Y}$ |
| 1 | 229 | 114 |
| 2 | 520 | 114 |
| 3 | 636 | 304 |
| 4 | 636 | 531 |
| 5 | 114 | 531 |
| 6 | 114 | 304 |


| Pad No. |  |  | Pin | Name | Description |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 5027A $\times$ 5027M× 5027Q | $\begin{aligned} & 5027 \mathrm{~B} \times \\ & 5027 \mathrm{~N} \times \\ & 5027 \mathrm{R} \times \end{aligned}$ | $\begin{aligned} & 5027 \mathrm{C} \times \\ & 5027 \mathrm{P} \times \\ & 5027 \mathrm{~S} \times \end{aligned}$ |  |  |  |
| 1 | 2 | 1 | XT | Amplifier input | Crystal connection pins. Crystal is connected between XT and XTN. |
| 2 | 1 | 2 | XTN | Amplifier output |  |
| 3 | 6 | 5 | VDD | (+) supply voltage | - |
| 4 | 5 | 4 | Q | Output | Output frequency determined by internal circuit to one of $\mathrm{f}_{\mathrm{O}}, \mathrm{f}_{\mathrm{O}} / 2, \mathrm{f}_{\mathrm{o}} / 4, \mathrm{f}_{\mathrm{O}} / 8, \mathrm{f}_{\mathrm{o}} / 16, \mathrm{f}_{0} / 32, \mathrm{f}_{\mathrm{O}} / 64$ |
| 5 | 4 | 3 | VSS | (-) ground | - |
| 6 | 3 | 6 | INHN | Output state control input | High impedance when LOW (oscillator stops). Power-saving pull-up resistor built-in. |

## BLOCK DIAGRAM



## VERSION DISCRIMINATION INTERNAL COMPONENTS

The WF5027 series device version is not determined solely by the mask pattern, but can also be determined by the trimming of internal trimming fuses.

- Version determined by laser trimming:

These chips are produced from a common device by the laser trimming of fuses corresponding to the ordered version, shown in table 1 . These devices are shipped for electrical characteristics testing. Laser-trimmed versions are identified externally by the combination of the version name marking (1) and the locations of trimmed fuses (2).

- Version determined by mask pattern:

These chips are fabricated using the mask corresponding to the ordered version, and do not require trimming. Mask-fabricated versions are identified externally by the version name marking (1) only.

Since the WF5027 series devices are manufactured using 2 methods, there are 2 types of IC chip available (identified externally) for the same version name. The identification markings for all WF5027 series device versions is shown in table 2.


Table 1. Version and trimming fuses (for fundamental oscillator)

| Version | Trimming fuse number ${ }^{* 1}$ |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | F1 | F2 | F3 | F4 | F5 |
| $5027 \times 1$ | - | - | - | - | - |
| $5027 \times 2$ | $\times$ | - | - | - | - |
| $5027 \times 3$ | - | $\times$ | - | - | - |
| $5027 \times 4$ | $\times$ | $\times$ | - | - | - |
| $5027 \times 5$ | - | - | $\times$ | - | - |
| $5027 \times 6$ | $\times$ | - | $\times$ | - | - |
| $5027 \times 7$ | - | $\times$ | $\times$ | - | - |
| $5027 \times P$ | - | - | - | $\times$ | $\times$ |
| $5027 \times Q$ | $\times$ | - | - | $\times$ | $\times$ |
| $5027 \times R$ | - | $\times$ | - | $\times$ | $\times$ |
| $5027 \times S$ | $\times$ | $\times$ | - | $\times$ | $\times$ |
| $5027 \times T$ | - | - | $\times$ | $\times$ | $\times$ |
| $5027 \times \mathrm{V}$ | $\times$ | - | $\times$ | $\times$ | $\times$ |
| $5027 \times W$ | - | $\times$ | $\times$ | $\times$ | $\times$ |

*1. -: untrimmed, $\times$ : trimmed, F6 to F9 not used

- $5027 \times 1$ trimming fuses (untrimmed)

- $5027 \times 2$ trimming fuses (F1 link trimmed)

- $5027 \times 3$ trimming fuses (F2 link trimmed)

- $5027 \times 4$ trimming fuses (F1 and F2 links trimmed)

: trimmed device

Table 2. Version and trimming fuses (for 3rd overtone oscillator)

| Version | Recommended oscillation frequency range ${ }^{* 1}$ [MHz] | Trimming fuse number* ${ }^{*}$ |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | F1 | F2 | F3 | F4 | F5 | F6 | F7 | F8 | F9 |
| $5027 \times$ A | 40 to 50 | - | - | - | - | - | - | $\times$ | $\times$ | $\times$ |
| $5027 \times$ B | 50 to 65 | - | $\times$ | - | - | - | - | - | $\times$ | $\times$ |
| $5027 \times C$ | 65 to 85 | $\times$ | $\times$ | - | - | $\times$ | - | $\times$ | - | $\times$ |
| $5027 \times$ D | 85 to 110 | - | $\times$ | $\times$ | $\times$ | $\times$ | - | $\times$ | - | $\times$ |
| 5027×E | (110 to 145) | TBD |  |  |  |  |  |  |  |  |
| 5027×F | (145 to 180) |  |  |  |  |  |  |  |  |  |

*1. Values in parentheses () are provisional only.
*2. -: untrimmed, $\times$ : trimmed

Table 3. Version identification by version name and chip markings (for fundamental oscillator)

*1. -: untrimmed, $\times$ : trimmed

Table 4. Version identification by version name and chip markings (for 3rd overtone oscillator)

| Version name | Version set by trimming fuses |  |  |  |  |  |  |  |  |  | Version set by mask pattern |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Version code on chip | Trimming fuses ${ }^{*}$ |  |  |  |  |  |  |  |  | Version code | Trimming fuses |
|  |  | F1 | F2 | F3 | F4 | F5 | F6 | F7 | F8 | F9 |  | F1 to F9 |
| 5027MA | MX | - | - | - | - | - | - | $\times$ | $\times$ | $\times$ | MA | Untrimmed |
| 5027MB | MX | - | $\times$ | - | - | - | - | - | $\times$ | $\times$ | MB |  |
| 5027MC | MX | $\times$ | $\times$ | - | - | $\times$ | - | $\times$ | - | $\times$ | MC |  |
| 5027MD | MX | - | $\times$ | $\times$ | $\times$ | $\times$ | - | $\times$ | - | $\times$ | MD |  |
| 5027NA | NX | - | - | - | - | - | - | $\times$ | $\times$ | $\times$ | NA |  |
| 5027NB | NX | - | $\times$ | - | - | - | - | - | $\times$ | $\times$ | NB |  |
| 5027NC | NX | $\times$ | $\times$ | - | - | $\times$ | - | $\times$ | - | $\times$ | NC |  |
| 5027ND | NX | - | $\times$ | $\times$ | $\times$ | $\times$ | - | $\times$ | - | $\times$ | ND |  |
| 5027PA | PX | - | - | - | - | - | - | $\times$ | $\times$ | $\times$ | PA |  |
| 5027PB | PX | - | $\times$ | - | - | - | - | - | $\times$ | $\times$ | PB |  |
| 5027PC | PX | $\times$ | $\times$ | - | - | $\times$ | - | $\times$ | - | $\times$ | PC |  |
| 5027PD | PX | - | $\times$ | $\times$ | $\times$ | $\times$ | - | $\times$ | - | $\times$ | PD |  |
| (5027QE) | TBD |  |  |  |  |  |  |  |  |  |  |  |
| (5027QF) |  |  |  |  |  |  |  |  |  |  |  |  |  |
| (5027RE) |  |  |  |  |  |  |  |  |  |  |  |  |  |
| (5027RF) |  |  |  |  |  |  |  |  |  |  |  |  |  |
| (5027SE) |  |  |  |  |  |  |  |  |  |  |  |  |  |
| (5027SF) |  |  |  |  |  |  |  |  |  |  |  |  |  |

*1. -: untrimmed, $\times$ : trimmed

## SPECIFICATIONS

## Absolute Maximum Ratings

$V_{S S}=0 V$

| Parameter | Symbol | Condition | Rating | Unit |
| :--- | :---: | :--- | :---: | :---: |
| Supply voltage range | $\mathrm{V}_{\mathrm{DD}}$ | Between VDD and VSS | -0.5 to +4.0 | V |
| Input voltage range | $\mathrm{V}_{\text {IN }}$ | Input pins | -0.5 to $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| Output voltage range | $\mathrm{V}_{\text {OUT }}$ | Output pins | -0.5 to $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| Storage temperature range | $\mathrm{T}_{\text {STG }}$ | Wafer form | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Output current | $\mathrm{I}_{\text {OUT }}$ | Q pin | $\pm 20$ | mA |

## Recommended Operating Conditions

## For Fundamental Oscillator

$\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$

| Parameter | Symbol | Condition |  | Rating |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| Operating supply voltage | $V_{D D}$ | $\mathrm{CL} \leq 15 \mathrm{pF}$ |  | 1.60 | - | 3.63 | V |
| Input voltage | $\mathrm{V}_{\text {IN }}$ | Input pins |  | $\mathrm{V}_{S S}$ | - | $V_{D D}$ | V |
| Operating temperature | TOPR |  |  | -40 | - | +85 | ${ }^{\circ} \mathrm{C}$ |
| Oscillation frequency ${ }^{* 1}$ | $f_{0}$ | $5027 \times 1$ to $5027 \times 7$ |  | 20 | - | 60 | MHz |
|  |  | $5027 \times P$ to $5027 \times W$ |  | 60 | - | 100 | MHz |
| Output frequency | $\mathrm{f}_{\text {OUT }}$ | $\mathrm{CL} \leq 15 \mathrm{pF}$ | $5027 \times 1$ to $5027 \times 7$ | 0.9 | - | 60 | MHz |
|  |  |  | $5027 \times$ P to 5027×W | 0.9 | - | 100 | MHz |

*1. The oscillation frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

## For 3rd Overtone Oscillator

$\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$

| Parameter | Symbol | Condition | Rating |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Operating supply voltage | $V_{D D}$ | $\mathrm{CL} \leq 15 \mathrm{pF}$ | 1.60 | - | 3.63 | V |
| Input voltage | $\mathrm{V}_{\text {IN }}$ | Input pins | $\mathrm{V}_{S S}$ | - | $V_{D D}$ | V |
| Operating temperature | TOPR |  | -40 | - | +85 | ${ }^{\circ} \mathrm{C}$ |
| Oscillation frequency ${ }^{* 1}$ | $\mathrm{f}_{0}$ | $5027 \times$ A | 40 | - | 50 | MHz |
|  |  | $5027 \times$ B | 50 | - | 65 | MHz |
|  |  | $5027 \times C$ | 65 | - | 85 | MHz |
|  |  | $5027 \times$ D | 85 | - | 110 | MHz |

*1. The oscillation frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

Electrical Characteristics

## DC Characteristics

For Fundamental Oscillator: Low frequency version (5027×1 to 5027×7)
$\mathrm{V}_{\mathrm{DD}}=1.60$ to $3.63 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+85^{\circ} \mathrm{C}$ unless otherwise noted.

| Parameter | Symbol | Condition |  | Rating |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| HIGH-level output voltage | $\mathrm{V}_{\mathrm{OH}}$ | Q: Measurement cct 3, $\mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA}$ |  | $V_{D D}-0.4$ | - | - | V |
| LOW-level output voltage | $\mathrm{V}_{\text {OL }}$ | Q: Measurement cct $3, \mathrm{I}_{0 \mathrm{~L}}=4 \mathrm{~mA}$ |  | - | - | 0.4 | V |
| HIGH-level input voltage | $\mathrm{V}_{\mathrm{IH}}$ | INHN, Measurement cct 4 |  | $0.7 \mathrm{~V}_{\mathrm{DD}}$ | - | - | V |
| LOW-level input voltage | $\mathrm{V}_{\text {IL }}$ | INHN, Measurement cct 4 |  | - | - | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V |
| Output leakage current | $\mathrm{I}_{\mathrm{z}}$ | Q: Measurement cct 5,INHN = LOW | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}$ | - | - | 10 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{OL}}=\mathrm{V}_{\text {SS }}$ | - 10 | - | - | $\mu \mathrm{A}$ |
| Current consumption*1 | $I_{D D}$ | $5027 \times 1\left(f_{0}\right)$, Measurement cct 1 , no load, $\operatorname{INHN}=$ open, $f_{0}=48 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=48 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.6 | 2.4 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ | - | 1.3 | 2.0 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.0 | 1.5 | mA |
|  |  | $5027 \times 2\left(\mathrm{f}_{\mathrm{o}} / 2\right)$, Measurement cct 1 , no load, $\operatorname{INHN}=$ open, $f_{0}=48 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=24 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.5 | 2.3 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 1.2 | 1.8 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 0.9 | 1.4 | mA |
|  |  | $5027 \times 3$ ( $\mathrm{f}_{\mathrm{o}} / 4$ ), Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=48 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=12 \mathrm{MHz}$ | $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ | - | 1.3 | 2.0 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 1.0 | 1.5 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 0.8 | 1.2 | mA |
|  |  | $5027 \times 4\left(\mathrm{f}_{0} / 8\right)$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=48 \mathrm{MHz}$, $\mathrm{f}_{\mathrm{OUT}}=6 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.1 | 1.7 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 0.9 | 1.4 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 0.75 | 1.15 | mA |
|  |  | $5027 \times 5\left(\mathrm{f}_{\mathrm{o}} / 16\right)$, Measurement cct 1 , no load, $\operatorname{INHN}=$ open, $f_{0}=48 \mathrm{MHz}$, $\mathrm{f}_{\mathrm{OUT}}=3 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.05 | 1.6 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 0.85 | 1.3 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 0.7 | 1.1 | mA |
|  |  | $5027 \times 6$ ( $\mathrm{f}_{\mathrm{o}} / 32$ ), Measurement cct 1 , no load, $\operatorname{INHN}=$ open, $f_{0}=48 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=1.5 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.0 | 1.5 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 0.85 | 1.3 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 0.7 | 1.1 | mA |
|  |  | $5027 \times 7$ ( $\mathrm{f}_{\mathrm{O}} / 64$ ), Measurement cct 1 , no load, $\operatorname{INHN}=$ open, $f_{0}=60 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=0.94 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.0 | 1.5 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ | - | 0.85 | 1.3 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 0.7 | 1.1 | mA |
| Standby current | $I_{\text {ST }}$ | Measurement cct 1, INHN = LOW |  | - | - | 10 | $\mu \mathrm{A}$ |
| INHN pull-up resistance | RUP1 | Measurement cct 6 |  | 0.4 | 1.5 | 8 | $\mathrm{M} \Omega$ |
|  | $\mathrm{R}_{\text {UP2 }}$ |  |  | 30 | 70 | 150 | k $\Omega$ |
| Oscillator feedback resistance | $\mathrm{R}_{\mathrm{f}}$ |  |  | 50 | 100 | 200 | $\mathrm{k} \Omega$ |
| Oscillator capacitance | $\mathrm{C}_{G}$ | Design value (a monitor pattern on a wafer is tested), Excluding parasitic capacitance. |  | 4.8 | 6 | 7.2 | pF |
|  | $\mathrm{C}_{\mathrm{D}}$ |  |  | 8 | 10 | 12 | pF |

${ }^{*}$. The consumption current $I_{D D}\left(C_{L}\right)$ with a load capacitance $\left(C_{L}\right)$ connected to the $Q$ pin is given by the following equation, where $I_{D D}$ is the no-load consumption current and $f_{\text {OUT }}$ is the output frequency.
$I_{D D}\left(C_{L}\right)[\mathrm{mA}]=I_{D D}[\mathrm{~mA}]+\mathrm{C}_{\mathrm{L}}[\mathrm{pF}] \times \mathrm{V}_{\mathrm{DD}}[\mathrm{V}] \times \mathrm{f}_{\mathrm{OUT}}[\mathrm{MHz}] \times 10^{-3}$

For Fundamental Oscillator: High frequency version (5027×P to $5027 \times W$ )
$\mathrm{V}_{\mathrm{DD}}=1.60$ to $3.63 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+85^{\circ} \mathrm{C}$ unless otherwise noted.

| Parameter | Symbol | Condition |  | Rating |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| HIGH-level output voltage | $\mathrm{V}_{\mathrm{OH}}$ | Q: Measurement $\operatorname{cct} 3, \mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA}$ |  | $V_{D D}-0.4$ | - | - | V |
| LOW-level output voltage | $\mathrm{V}_{\mathrm{OL}}$ | Q: Measurement cct $3, \mathrm{I}_{0 \mathrm{~L}}=4 \mathrm{~mA}$ |  | - | - | 0.4 | V |
| HIGH-level input voltage | $\mathrm{V}_{\mathrm{IH}}$ | INHN, Measurement cct 4 |  | $0.7 \mathrm{~V}_{\text {DD }}$ | - | - | V |
| LOW-level input voltage | $\mathrm{V}_{\text {IL }}$ | INHN, Measurement cct 4 |  | - | - | $0.3 \mathrm{~V}_{\text {DD }}$ | V |
| Output leakage current | $\mathrm{I}_{\mathrm{z}}$ | Q: Measurement cct 5, INHN = LOW | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}$ | - | - | 10 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{OL}}=\mathrm{V}_{\text {SS }}$ | - 10 | - | - | $\mu \mathrm{A}$ |
| Current consumption ${ }^{* 1}$ | $I_{\text {DD }}$ | $5027 \times \mathrm{P}\left(\mathrm{f}_{\mathrm{O}}\right)$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=80 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=80 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 2.5 | 3.8 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 2.0 | 3.0 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.6 | 2.4 | mA |
|  |  | $5027 \times \mathrm{Q}\left(\mathrm{f}_{\mathrm{o}} / 2\right)$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=80 \mathrm{MHz}$, $\mathrm{f}_{\mathrm{OUT}}=40 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 2.4 | 3.6 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 1.9 | 2.9 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.5 | 2.3 | mA |
|  |  | $5027 \times \mathrm{R}\left(\mathrm{f}_{\mathrm{O}} / 4\right)$, Measurement cct 1 , no load, $\operatorname{INHN}=$ open, $f_{0}=80 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=20 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.8 | 2.7 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 1.5 | 2.3 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.2 | 1.6 | mA |
|  |  | $5027 \times \mathrm{S}\left(\mathrm{f}_{\mathrm{o}} / 8\right)$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=80 \mathrm{MHz}$, $f_{\text {OUT }}=10 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.7 | 2.6 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 1.4 | 2.1 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.1 | 1.7 | mA |
|  |  | $5027 \times \mathrm{T}\left(\mathrm{f}_{\mathrm{o}} / 16\right)$, Measurement cot 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=80 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=5 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.6 | 2.4 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ | - | 1.3 | 2.0 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.0 | 1.5 | mA |
|  |  | $5027 \times \mathrm{V}\left(\mathrm{f}_{\mathrm{o}} / 32\right)$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=80 \mathrm{MHz}$, $\mathrm{f}_{\text {OUT }}=2.5 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.5 | 2.3 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 1.2 | 1.8 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.0 | 1.5 | mA |
|  |  | $5027 \times W$ ( $\mathrm{f}_{\mathrm{o}} / 64$ ), Measurement cct 1 , no load, INHN = open, $\mathrm{f}_{\mathrm{O}}=80 \mathrm{MHz}$, $\mathrm{f}_{\mathrm{OUT}}=1.25 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 1.5 | 2.3 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 1.2 | 1.8 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 1.0 | 1.5 | mA |
| Standby current | $I_{\text {ST }}$ | Measurement cct 1, INHN = LOW |  | - | - | 10 | $\mu \mathrm{A}$ |
| INHN pull-up resistance | RUP1 | Measurement cct 6 |  | 0.4 | 1.5 | 8 | $\mathrm{M} \Omega$ |
|  | $\mathrm{R}_{\text {UP2 }}$ |  |  | 30 | 70 | 150 | k $\Omega$ |
| Oscillator feedback resistance | $\mathrm{R}_{\mathrm{f}}$ |  |  | 50 | 100 | 200 | $\mathrm{k} \Omega$ |
| Oscillator capacitance | $\mathrm{C}_{\mathrm{G}}$ | Design value (a monitor pattern on a wafer is tested), Excluding parasitic capacitance. |  | 1.6 | 2 | 2.4 | pF |
|  | $\mathrm{C}_{\mathrm{D}}$ |  |  | 3.2 | 4 | 4.8 | pF |

*1. The consumption current $I_{D D}\left(C_{L}\right)$ with a load capacitance $\left(C_{L}\right)$ connected to the $Q$ pin is given by the following equation, where $I_{D D}$ is the no-load consumption current and $\mathrm{f}_{\text {OUT }}$ is the output frequency.
$I_{D D}\left(C_{L}\right)[\mathrm{mA}]=I_{D D}[\mathrm{~mA}]+C_{L}[\mathrm{pF}] \times V_{D D}[V] \times f_{O U T}[M H z] \times 10^{-3}$

## For 3rd Overtone Oscillator (5027×A to 5027×D)

$\mathrm{V}_{\mathrm{DD}}=1.60$ to $3.63 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+85^{\circ} \mathrm{C}$ unless otherwise noted.

| Parameter | Symbol | Condition |  | Rating |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| HIGH-level output voltage | $\mathrm{V}_{\mathrm{OH}}$ | Q: Measurement cct $3, \mathrm{I}_{\mathrm{OH}}=-8 \mathrm{~mA}$, $V_{D D}=2.25$ to 3.63 V |  | $V_{D D}-0.4$ | - | - | V |
|  |  | Q: Measurement cct $3, \mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA}$, $V_{D D}=1.60$ to 2.25 V |  | $V_{D D}-0.4$ | - | - | V |
| LOW-level output voltage | $\mathrm{V}_{\mathrm{OL}}$ | Q: Measurement cct $3, \mathrm{I}_{\mathrm{OL}}=8 \mathrm{~mA}$, $V_{D D}=2.25$ to 3.63 V |  | - | - | 0.4 | V |
|  |  | Q: Measurement cct $3, \mathrm{I}_{\mathrm{OL}}=4 \mathrm{~mA}$, $V_{D D}=1.60$ to 2.25 V |  | - | - | 0.4 | V |
| HIGH-level input voltage | $\mathrm{V}_{\mathrm{IH}}$ | INHN, Measurement cct 4 |  | $0.7 \mathrm{~V}_{\mathrm{DD}}$ | - | - | V |
| LOW-level input voltage | $\mathrm{V}_{\text {IL }}$ | INHN, Measurement cct 4 |  | - | - | $0.3 \mathrm{~V}_{\text {DD }}$ | V |
| Output leakage current | $I_{z}$ | Q: Measurement cct 5, INHN = LOW | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{DD}}$ | - | - | 10 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{OL}}=\mathrm{V}_{\text {SS }}$ | -10 | - | - | $\mu \mathrm{A}$ |
| Current consumption* ${ }^{* 1}$ | $I_{D D}$ | $5027 \times A$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=48 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 3.6 | 5.4 | mA |
|  |  |  | $V_{D D}=2.5 \mathrm{~V}$ | - | 3.0 | 4.5 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 2.6 | 3.9 | mA |
|  |  | $5027 \times B$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=54 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 3.8 | 5.7 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ | - | 3.2 | 4.8 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 2.8 | 4.2 | mA |
|  |  | $5027 \times C$, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=85 \mathrm{MHz}$ | $V_{D D}=3.3 \mathrm{~V}$ | - | 4.8 | 7.2 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ | - | 4.0 | 6.0 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V}$ | - | 3.4 | 5.1 | mA |
|  |  | $5027 \times$ D, Measurement cct 1 , no load, $\mathrm{INHN}=$ open, $\mathrm{f}_{\mathrm{O}}=100 \mathrm{MHz}$ | $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ | - | 5.3 | 8.0 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ | - | 4.4 | 6.6 | mA |
|  |  |  | $V_{D D}=1.8 \mathrm{~V}$ | - | 3.6 | 5.4 | mA |
| Standby current | $\mathrm{I}_{\text {ST }}$ | Measurement cct 1, INHN = LOW |  | - | - | 10 | $\mu \mathrm{A}$ |
| INHN pull-up resistance | $\mathrm{R}_{\text {UP1 }}$ | Measurement cct 6 |  | 0.4 | 1.5 | 8 | $\mathrm{M} \Omega$ |
|  | RUP2 |  |  | 30 | 70 | 150 | $\mathrm{k} \Omega$ |
| Oscillator feedback resistance | $\mathrm{R}_{\mathrm{f}}$ | $5027 \times \mathrm{A}$ |  | 2.6 | 3.8 | 5.0 | k $\Omega$ |
|  |  | 5027×B |  | 2.2 | 3.2 | 4.2 | $\mathrm{k} \Omega$ |
|  |  | $5027 \times$ C |  | 1.9 | 2.8 | 3.7 | k $\Omega$ |
|  |  | $5027 \times$ D |  | 1.9 | 2.8 | 3.7 | $\mathrm{k} \Omega$ |
| Oscillator capacitance | $\mathrm{C}_{G}$ | Design value (a monitor pattern on a wafer is tested), <br> Excluding parasitic capacitance. | $5027 \times \mathrm{A}$ | 9.6 | 12 | 14.4 | pF |
|  |  |  | $5027 \times B$ | 6.4 | 8 | 9.6 | pF |
|  |  |  | 5027×C | 4.8 | 6 | 7.2 | pF |
|  |  |  | 5027×D | 1.6 | 2 | 2.4 | pF |
|  | $C_{\text {D }}$ | Design value (a monitor pattern on a wafer is tested), <br> Excluding parasitic capacitance. | $5027 \times \mathrm{A}$ | 9.6 | 12 | 14.4 | pF |
|  |  |  | $5027 \times B$ | 9.6 | 12 | 14.4 | pF |
|  |  |  | $5027 \times$ C | 6.4 | 8 | 9.6 | pF |
|  |  |  | 5027×D | 4.8 | 6 | 7.2 | pF |

[^0]
## AC Characteristics

## For Fundamental Oscillator (5027 $\times 1$ to $5027 \times 7,5027 \times$ P to $5027 \times W$ )

$\mathrm{V}_{\mathrm{DD}}=1.60$ to $3.63 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+85^{\circ} \mathrm{C}$ unless otherwise noted.

| Parameter | Symbol | Condition |  | Rating |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| Output rise time | $\mathrm{t}_{\mathrm{r}}$ | Measurement cct 1, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, $0.1 \mathrm{~V}_{\mathrm{DD}}$ to $0.9 \mathrm{~V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}=2.25$ to 3.36 V | - | 2.0 | 4.5 | ns |
|  | $\mathrm{t}_{\mathrm{r} 2}$ |  | $V_{D D}=1.60$ to 2.25 V | - | 3.0 | 5.0 | ns |
| Output fall time | $\mathrm{t}_{\mathrm{f} 1}$ | $\text { Measurement cct } 1, C_{L}=15 \mathrm{pF} \text {, }$$0.9 \mathrm{~V}_{\mathrm{DD}} \text { to } 0.1 \mathrm{~V}_{\mathrm{DD}}$ | $V_{D D}=2.25$ to 3.36 V | - | 2.0 | 4.5 | ns |
|  | $\mathrm{t}_{\mathrm{t} 2}$ |  | $\mathrm{V}_{\mathrm{DD}}=1.60$ to 2.25 V | - | 3.0 | 5.0 | ns |
| Output duty cycle | Duty | Measurement cct 1, $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 45 | 50 | 55 | \% |
| Output disable delay time | $\mathrm{t}_{\mathrm{OD}}$ | Measurement cct $2, \mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}} \leq 15 \mathrm{pF}$ |  | - | - | 50 | $\mu \mathrm{s}$ |

## For 3rd Overtone Oscillator (5027×A to $5027 \times D$ )

$\mathrm{V}_{\mathrm{DD}}=1.60$ to $3.63 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+85^{\circ} \mathrm{C}$ unless otherwise noted.

| Parameter | Symbol | Condition |  | Rating |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | min | typ | max |  |
| Output rise time | $\mathrm{t}_{\mathrm{r} 1}$ | Measurement cct 1, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, $0.1 \mathrm{~V}_{\mathrm{DD}}$ to $0.9 \mathrm{~V}_{\mathrm{DD}}$ | $V_{\text {DD }}=2.25$ to 3.36 V | - | 1.2 | 3.0 | ns |
|  | $\mathrm{t}_{\mathrm{r} 2}$ |  | $V_{D D}=1.60$ to 2.25 V | - | 1.6 | 4.0 | ns |
| Output fall time | $\mathrm{t}_{\mathrm{f} 1}$ | Measurement cct 1, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, $0.9 \mathrm{~V}_{\mathrm{DD}}$ to $0.1 \mathrm{~V}_{\mathrm{DD}}$ | $V_{D D}=2.25$ to 3.36 V | - | 1.2 | 3.0 | ns |
|  | $\mathrm{t}_{\mathrm{f} 2}$ |  | $V_{D D}=1.60$ to 2.25 V | - | 1.6 | 4.0 | ns |
| Output duty cycle | Duty | Measurement cct 1, $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 45 | 50 | 55 | \% |
| Output disable delay time | $t_{0 D}$ | Measurement cct $2, \mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}} \leq 15 \mathrm{pF}$ |  | - | - | 50 | $\mu \mathrm{s}$ |

## Timing chart



Figure 1. Output switching waveform


When INHN goes HIGH to LOW, the Q output goes HIGH once and then becomes high impedance.
When INHN goes LOW to HIGH, the Q output goes from high impedance to normal output operation when the oscillation starts (oscillation is detected). ${ }^{*}$ ) The high-impedance interval in the figure is shown as a LOW level due to the $1 \mathrm{k} \Omega$ pull-down resistor connected to the $Q$ pin (see "Measurement circuit 2 " in the "Measurement Circuits" section).

Figure 2. Output disable and oscillation start timing chart

## FUNCTIONAL DESCRIPTION

## Standby Function

When INHN goes LOW, the Q output becomes high impedance.

| INHN | Q | Oscillator |
| :---: | :---: | :---: |
| HIGH (or open) | Frequency output | Normal operation |
| LOW | High impedance | Stopped |

## Power-saving Pull-up Resistor

The INHN pin pull-up resistance $\mathrm{R}_{\mathrm{UP} 1}$ or $\mathrm{R}_{\mathrm{UP} 2}$ changes in response to the input level (HIGH or LOW). When INHN is tied LOW level, the pull-up resistance is large $\left(R_{U P 1}\right)$, reducing the current consumed by the resistance. When INHN is left open circuit, the pull-up resistance is small $\left(R_{U P 2}\right)$, which increases the input susceptibility to external noise. However, the pull-up resistance ties the INHN pin HIGH level to prevent external noise from unexpectedly stopping the output.

## Oscillation Detector Function

The WF5027 series also feature an oscillation detector circuit. This circuit functions to disable the outputs until the oscillator circuit starts and oscillation becomes stable. This alleviates the danger of abnormal oscillator output at oscillator start-up when power is applied or when INHN is switched.

## MEASUREMENT CIRCUITS

## Measurement cct 1

Measurement parameter: $\mathrm{I}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{ST}}$, Duty, $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$


Note: The AC characteristics are observed using an oscilloscope on pin $Q$.

## Measurement cct 2

Measurement parameter: $\mathrm{t}_{\mathrm{OD}}$


XTN input signal: 1Vp-p, sine wave
C1: $0.001 \mu \mathrm{~F}$
$\mathrm{C}_{\mathrm{L}}: 15 \mathrm{pF}$
R1: $50 \Omega$
$R_{L}: 1 \mathrm{k} \Omega$

## Measurement cct 3

Measurement parameter: $\mathrm{V}_{\mathrm{OH}}, \mathrm{V}_{\mathrm{OL}}$

$\mathrm{V}_{\mathrm{S}}$ adjusted such that $\Delta \mathrm{V}=\quad \mathrm{V}_{\mathrm{S}}$ adjusted such that $\Delta \mathrm{V}=$ $50 \times \mathrm{I}_{\mathrm{OH}}$.

$$
50 \times \mathrm{I}_{\mathrm{OL}} .
$$

XTN input signal: 1Vp-p, sine wave


## Measurement cct 4

Measurement parameter: $\mathrm{V}_{\mathrm{IH}}, \mathrm{V}_{\mathrm{IL}}$

$\mathrm{V}_{\mathrm{IH}}$ : Voltage in $\mathrm{V}_{S S}$ to $\mathrm{V}_{\mathrm{DD}}$ transition that changes the output state.
$\mathrm{V}_{\text {IL }}$ : Voltage in $\mathrm{V}_{D D}$ to $\mathrm{V}_{S S}$ transition that changes the output state. INHN has an oscillation stop function.

## Measurement cct 5

Measurement parameter: $\mathrm{I}_{Z}$


## Measurement cct 6

Measurement parameter: $\mathrm{R}_{\mathrm{UP} 1}, \mathrm{R}_{\mathrm{UP} 2}$


## TYPICAL PERFORMANCE (for fundamental oscillator)

The following characteristics measured using the crystal below. Note that the characteristics will vary with the crystal used.

- Crystal used for measurement

| Parameter | $\mathrm{f}_{0}=\mathbf{4 8 M H z}$ | $\mathrm{f}_{\mathbf{0}}=\mathbf{8 0 M H z}$ |
| :---: | :---: | :---: |
| $\mathrm{C} 0[\mathrm{pF}]$ | 1.6 | 2.1 |
| $\mathrm{R} 1[\Omega]$ | 12 | 10 |

## Current Consumption

- Crystal parameters


$5027 \mathrm{Al}, \mathrm{f}_{\mathrm{OUT}}=48 \mathrm{MHz}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

$5027 \mathrm{AP}, \mathrm{f}_{\text {OUT }}=80 \mathrm{MHz}, \mathrm{Ta}=25^{\circ} \mathrm{C}$


## Negative Resistance



Characteristics are measured with a capacitance $\mathbf{C O}$, representing the crystal equivalent circuit $\mathbf{C O}$ capacitance, connected between the XT and XTN pins. Measurements are performed with Agilent 4396B using the NPC test jig. Characteristics may vary with measurement jig and measurement conditions.

## Frequency Deviation by Supply Voltage Change


$5027 \times 1$ to $\times 7, \mathrm{f}_{\mathrm{OUT}}=48 \mathrm{MHz}$,
3.3 V standard, $\mathrm{Ta}=25^{\circ} \mathrm{C}$

$5027 \times \mathrm{P}$ to $\times \mathrm{W}, \mathrm{f}_{\text {OUT }}=80 \mathrm{MHz}$,
3.3 V standard, $\mathrm{Ta}=25^{\circ} \mathrm{C}$

## Drive Level


$5027 \times 1$ to $\times 7, \mathrm{f}_{\mathrm{OUT}}=48 \mathrm{MHz}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

$5027 \times \mathrm{P}$ to $\times \mathrm{W}, \mathrm{f}_{\text {OUT }}=80 \mathrm{MHz}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

## Phase Noise

Measurement equipment: Agilent E5052 Signal Source Analyzer

$5027 \mathrm{~A} 1, \mathrm{~V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OSC}}=\mathrm{f}_{\mathrm{OUT}}=48 \mathrm{MHz}$,

$$
\mathrm{Ta}=25^{\circ} \mathrm{C}
$$


$5027 \mathrm{AP}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OSC}}=\mathrm{f}_{\mathrm{OUT}}=80 \mathrm{MHz}$,
$\mathrm{Ta}=25^{\circ} \mathrm{C}$

## Output Waveform

Measurement equipment: Agilent 54855A Oscilloscope

$5027 \mathrm{~A} 1, \mathrm{~V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OUT}}=48 \mathrm{MHz}$, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

$5027 \mathrm{AP}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OUT}}=80 \mathrm{MHz}$,
$\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

## TYPICAL PERFORMANCE (for 3rd overtone oscillator)

The following characteristics measured using the crystal below. Note that the characteristics will vary with the crystal used.

- Crystal used for measurement

| Parameter | $\mathbf{f}_{\mathbf{0}}=\mathbf{8 5 M H z}$ | $\mathrm{f}_{\mathbf{0}}=\mathbf{1 0 0 M H z}$ |
| :---: | :---: | :---: |
| $\mathrm{C} 0[\mathrm{pF}]$ | 0.9 | 1.2 |
| $\mathrm{R} 1[\Omega]$ | 56 | 45 |

## Current Consumption

- Crystal parameters




## Negative Resistance


$5027 \times \mathrm{D}, \mathrm{Ta}=25^{\circ} \mathrm{C}$, recommended operating frequency range: 85 MHz to 110 MHz

Characteristics are measured with a capacitance $\mathbf{C O}$, representing the crystal equivalent circuit $\mathbf{C O}$ capacitance, connected between the XT and XTN pins. Measurements are performed with Agilent 4396B using the NPC test jig. Characteristics may vary with measurement jig and measurement conditions.

## Frequency Deviation by Supply Voltage Change


$5027 \times \mathrm{D}, \mathrm{f}_{\text {OUT }}=85 \mathrm{MHz}, 3.3 \mathrm{~V}$ standard, $\mathrm{Ta}=25^{\circ} \mathrm{C}$

$5027 \times \mathrm{D}, \mathrm{f}_{\text {OUT }}=100 \mathrm{MHz}, 3.3 \mathrm{~V}$ standard, $\mathrm{Ta}=25^{\circ} \mathrm{C}$

## Drive Level



## Phase Noise

Measurement equipment: Agilent E5052 Signal Source Analyzer


$$
\begin{gathered}
5027 \times \mathrm{D}, \mathrm{~V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OSC}}=\mathrm{f}_{\mathrm{OUT}}=85 \mathrm{MHz}, \\
\mathrm{Ta}=25^{\circ} \mathrm{C}
\end{gathered}
$$



$$
\begin{gathered}
5027 \times \mathrm{D}, \mathrm{~V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OSC}}=\mathrm{f}_{\mathrm{OUT}}=100 \mathrm{MHz}, \\
\mathrm{Ta}=25^{\circ} \mathrm{C}
\end{gathered}
$$

## Output Waveform

Measurement equipment: Agilent 54855A Oscilloscope

$5027 \times \mathrm{D}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OUT}}=85 \mathrm{MHz}$,
$\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

$5027 \times \mathrm{D}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{f}_{\mathrm{OUT}}=100 \mathrm{MHz}$,
$\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{Ta}=25^{\circ} \mathrm{C}$

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[^0]:    *1. The consumption current $I_{D D}\left(C_{L}\right)$ with a load capacitance $\left(C_{L}\right)$ connected to the $Q$ pin is given by the following equation, where $I_{D D}$ is the no-load consumption current and $f_{\text {OUT }}$ is the output frequency.
    $I_{D D}\left(C_{L}\right)[\mathrm{mA}]=I_{D D}[\mathrm{~mA}]+\mathrm{C}_{\mathrm{L}}[\mathrm{pF}] \times \mathrm{V}_{\mathrm{DD}}[\mathrm{V}] \times \mathrm{f}_{\mathrm{OUT}}[\mathrm{MHz}] \times 10^{-3}$

